

Customer No.: 31561
Application No.: 10/710,663
Docket No.: 12262-US-PA

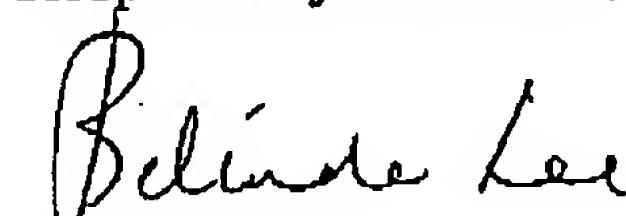
REMARKS

In response to the Office Action, mailed on September 11, 2006, a complete listing of all of the claims is presented herewith. Applicants would like to elect Group I, claims 1-7, drawn to a heat transfer device, classified in class 165, subclass 104.21. Please cancel Group II, claims 8-16, drawn to a method of making a heat transfer device, classified in class 29, subclass 890.030, without waiver, prejudice or disclaimer.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Date : Oct. 4, 2006

Respectfully submitted,


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